# Noninverting Buffer / CMOS Logic Level Shifter with LSTTL-Compatible Inputs

The MC74VHCT50A is a hex noninverting buffer fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

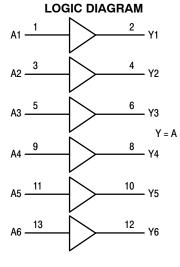
The internal circuit is composed of three stages, including a buffered output which provides high noise immunity and stable output.

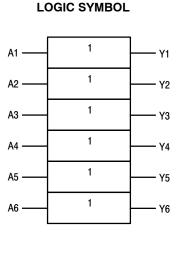
The device input is compatible with TTL-type input thresholds and the output has a full 5 V CMOS level output swing. The input protection circuitry on this device allows overvoltage tolerance on the input, allowing the device to be used as a logic-level translator from 3.0 V CMOS logic to 5.0 V CMOS Logic or from 1.8 V CMOS logic to 3.0 V CMOS Logic while operating at the high-voltage power supply.

The MC74VHCT50A input structure provides protection when voltages up to 7 V are applied, regardless of the supply voltage. This allows the MC74VHCT50A to be used to interface 5 V circuits to 3 V circuits. The output structures also provide protection when  $V_{CC} = 0$  V. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

#### Features

- High Speed:  $t_{PD} = 3.5 \text{ ns} (Typ)$  at  $V_{CC} = 5 \text{ V}$
- Low Power Dissipation:  $I_{CC} = 2 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- TTL-Compatible Inputs:  $V_{IL} = 0.8 \text{ V}$ ;  $V_{IH} = 2.0 \text{ V}$
- CMOS–Compatible Outputs:  $V_{OH} > 0.8 V_{CC}$ ;  $V_{OL} < 0.1 V_{CC}$  @Load
- Power Down Protection Provided on Inputs and Outputs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant





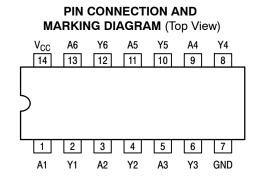


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D SUFFIX CASE 751A 14-LEAD TSSOF DT SUFFIX CASE 948G



For detailed package marking information, see the Marking Diagram section on page 4 of this data sheet.

#### **FUNCTION TABLE**

A Input	Y Output
L	L
н	Н

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

#### MAXIMUM RATINGS

Symbol		Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +7.0	V
V <sub>IN</sub>	DC Input Voltage		$-0.5 \leq V_{ } \leq +7.0$	V
V <sub>OUT</sub>	DC Output Voltage	Output in HIGH or LOW State	$-0.5 \leq V_O \leq +7.0$	V
I <sub>IK</sub>	DC Input Diode Current		-20	mA
I <sub>OK</sub>	DC Output Diode Current		±20	mA
lo	DC Output Source/Sink Current		±25	mA
I <sub>CC</sub>	DC Supply Current per Supply Pir	1	±50	mA
I <sub>GND</sub>	DC Ground Current per Ground P	in	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
TL	Lead Temperature, 1 mm from Ca	se for 10 Seconds	260	°C
TJ	Junction Temperature under Bias		+ 150	°C
$\theta_{JA}$	Thermal Resistance	(Note 1) SOIC TSSOP	125 170	°C/W
P <sub>D</sub>	Power Dissipation in Still Air	SOIC TSSOP	500 450	mW
V <sub>ESD</sub>	ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	> 2000 > 200 2000	V
I <sub>Latch-Up</sub>	Latch-Up Performance	Above $V_{CC}$ and Below GND at 85 $^{\circ}$ C (Note 5)	±300	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.

2. Tested to EIA/JESD22-A114-A.

3. Tested to EIA/JESD22-A115-A.

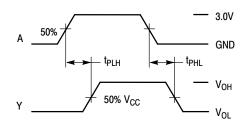
4. Tested to JESD22-C101-A.

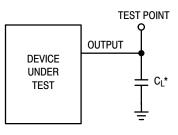
5. Tested to EIA/JESD78.

#### **RECOMMENDED OPERATING CONDITIONS**

Cł	naracteristics	Symbol	Min	Max	Unit
DC Supply Voltage		V <sub>CC</sub>	2.0	5.5	V
DC Input Voltage		V <sub>IN</sub>	0.0	5.5	V
DC Output Voltage	V <sub>CC</sub> = 0 High or Low State	V <sub>OUT</sub>	0.0 0.0	5.5 V <sub>CC</sub>	V
Operating Temperature Ra	nge	T <sub>A</sub>	-55	+125	°C
Input Rise and Fall Time		t <sub>r</sub> , t <sub>f</sub>	0 0	100 20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.





\*Includes all probe and jig capacitance

#### Figure 1. Switching Waveforms

#### Figure 2. Test Circuit

			Vcc	ר	Γ <sub>A</sub> = 25°0	C	<b>TA</b> ≤	85°C	<b>TA</b> ≤ <b>T</b>	125°C	
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Min	Max	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage		3.0 4.5 5.5	1.2 2.0 2.0			1.2 2.0 2.0		1.2 2.0 2.0		V
V <sub>IL</sub>	Maximum Low-Level Input Voltage		3.0 4.5 5.5			0.53 0.8 0.8		0.53 0.8 0.8		0.53 0.8 0.8	V
V <sub>OH</sub>	Minimum High-Level Output Voltage	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = –50 μA	3.0 4.5	2.9 4.4	3.0 4.5		2.9 4.4		2.9 4.4		V
	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OH} = -4 \text{ mA} \\ I_{OH} = -8 \text{ mA} \end{array}$	3.0 4.5	2.58 3.94			2.48 3.80		2.34 3.66		V
V <sub>OL</sub>	Maximum Low-Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 50 \ \mu A$	3.0 4.5		0.0 0.0	0.1 0.1		0.1 0.1		0.1 0.1	V
	$V_{IN} = V_{IH}$ or $V_{IL}$	$\label{eq:VIN} \begin{split} V_{IN} &= V_{IH} \text{ or } V_{IL} \\ I_{OH} &= -4 \text{ mA} \\ I_{OL} &= 8 \text{ mA} \end{split}$	3.0 4.5			0.36 0.36		0.44 0.44		0.52 0.52	V
I <sub>IN</sub>	Maximum Input Leakage Current	V <sub>IN</sub> = 5.5 V or GND	0 to 5.5			±0.1		±1.0		±1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5			2.0		20		40	μA
I <sub>CCT</sub>	Quiescent Supply Current	Input: V <sub>IN</sub> = 3.4 V	5.5			1.35		1.50		1.65	mA
I <sub>OFF</sub>	Output Leakage Current	V <sub>OUT</sub> = 5.5 V	0.0			0.5		5.0		10	μA

#### DC ELECTRICAL CHARACTERISTICS

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### AC ELECTRICAL CHARACTERISTICS ( $C_{load}$ = 50 pF, Input $t_r = t_f$ = 3.0ns)

				-	Γ <sub>A</sub> = 25°0	C	<b>T</b> <sub>A</sub> ≤	85°C	<b>TA</b> ≤ 1	125°C	
Symbol	Parameter	Test Condi	tions	Min	Тур	Max	Min	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propogation Delay,	$V_{CC} = 3.3 \pm 0.3 \text{ V}$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		5.5 8.0	7.9 11.4	1.0 1.0	9.5 13.0			ns
	Input A to Y	$V_{CC} = 5.0 \pm 0.5 \text{ V}$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		6.2 7.0	7.5 8.5		8.5 9.5		9.5 10.5	
C <sub>IN</sub>	Maximum Input Capacitance				5	10		10		10	pF

		Typical @ 25°C, V <sub>CC</sub> = 5.0 V	
C <sub>PD</sub>	Power Dissipation Capacitance (Note 6)	15	pF
6 Ciad	fined as the value of the internal equivalent experitence which is calculated from	the energting ourrest consumption wit	hout lood

6. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

## **NOISE CHARACTERISTICS** (Input $t_r = t_f = 3.0ns$ , $C_L = 50pF$ , $V_{CC} = 5.0V$ )

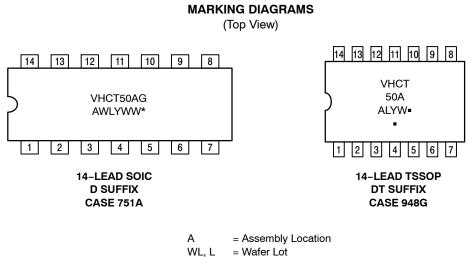
		T <sub>A</sub> = 25°C		
Symbol	Characteristic		Max	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	0.8	1.0	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	-0.8	-1.0	V
V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage		2.0	V
V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage		0.8	V

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74VHCT50ADR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel
MC74VHCT50ADTR2G	TSSOP-14	
NLVVHCT50ADTR2G*	(Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.



 A
 = Assembly Location

 WL, L
 = Wafer Lot

 Y
 = Year

 WW, W
 = Work Week

 G or •
 = Pb-Free Package

\*See Applications Note #AND8004/D for date code and traceability information.

# DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### DATE 03 FEB 2016

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